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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent application of:

Applicant(s): Paul A. Kohl et al.

Serial No: 09/717,567

Filing Date: November 21, 2000

Title: FABRICATION OF A SEMICONDUCTOR DEVICE WITH AIR GAPS
FOR ULTRA-LOW CAPACITANCE INTERCONNECTIONS

Examiner: James M. Mitchell

Art Unit: 2827

Docket No. BFGBP0217USA

REPLY TO NOTICE OF NON-COMPLIANT
AMENDMENT DATED AUGUST 17, 2004

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Attached is a corrected Amendment to the Claims which contains a complete listing of all of the claims.

Respectfully submitted,

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CERTIFICATE OF MAILING (37 CFR 1.8a)

I hereby certify that this paper (along with any paper or thing referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date: 9-17-04

Jennifer A. Moore
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